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| Substitute for form 1449/PTO | | Complete if Known | | | |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use as many sheets as necessary) | | Application Number | 10/688,186 – Conf. #4125 | | |
| | | Filing Date | September 24, 2003 | | |
| | | First Named Inventor | Yutaka TAKAFUJI | | |
| | | Art Unit | 2813 | | |
| | | Examiner Name | MENZ, Laura Mary | | |
| Sheet | 1 | of | 1 | Attorney Docket Number | 1248-0673P |

| U.S. PATENT DOCUMENTS | | | | | |
|-----------------------|--------------------------|---|--------------------------------|--|---|
| Examiner Initials* | Cite No. ¹ | Document Number Number-Kind Code ² (if known) | Publication Date MM-DD-YYYY | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear |
| | AA* | US-2002/0047169* | 04-25-2002 | Kunikiyo | |
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| FOREIGN PATENT DOCUMENTS | | | | | | |
|--------------------------|--------------------------|---|-----------------------------------|--|---|----------------|
| Examiner Initials* | Cite No. ¹ | Foreign Patent Document | Publication Date MM-DD-YYYY | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines, Where Relevant Passages Or Relevant Figures Appear | T ² |
| | | Country Code ³ -Number ⁴ -Kind Code ⁵ (if known) | | | | |
| | BA | JP-06-289421 | 10-18-1994 | Matsushita Electric Ind. Co. Ltd. | | ✓ |
| | BB | JP-2002-076336 | 03-15-2002 | Mitsubishi Electric Corp. | | ABS |
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| NON PATENT LITERATURE DOCUMENTS | | | | | |
|---------------------------------|--------------------------|---|--|--|----------------|
| Examiner Initials | Cite No. ¹ | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | | | T ² |
| | CA | C. GUI et al., "The effect of surface roughness on direct wafer bonding," Journal of Applied Physics, May 15, 1999, Volume 85, No. 10, pp. 7448-7454 | | | |
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|-----------------------|--------------------|
| Examiner Signature | Date Considered |
|-----------------------|--------------------|

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¹Applicant's unique citation designation number (optional). ²Applicant is to place a check mark here if English language Translation is etched.
(*) corresponding to JP 2002-76336A (BB)

Date: November 26, 2008

Not considered

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